

STP14NF10

N-channel 100 V - 0.115 Ω - 15 A - TO-220 low gate charge STripFETTM II Power MOSFET

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D
STP14NF10	100 V	< 0.13 Ω	15 A

- Exceptional dv/dt capability
- 100% avalanche tested
- Application oriented characterization

Application

■ Switching applications

Description

This Power MOSFET series realized with STMicroelectronics unique STripFETTM process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced highefficiency, high-frequency isolated DC-DC converters for telecom and computer applications. It is also intended for any applications with low gate drive requirements.

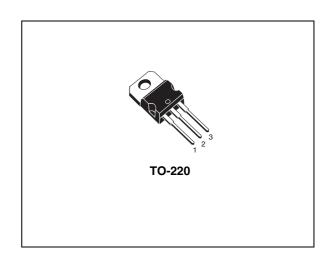


Figure 1. Internal schematic diagram

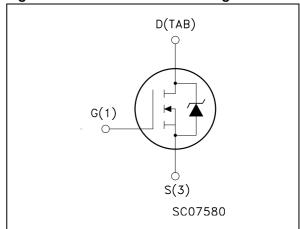


Table 1. Device summary

Order code	Marking	Package	Packaging
STP14NF10	P14NF10	TO-220	Tube

April 2008 Rev 4 1/12

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STP14NF10 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage (V _{GS} = 0)	100	V
V _{GS}	Gate- source voltage	± 20	V
I _D	Drain current (continuous) at T _C = 25 °C	15	Α
I _D	Drain current (continuous) at T _C = 100 °C	10	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	60	А
P _{tot}	Total dissipation at T _C = 25 °C	60	W
	Derating factor	0.4	W/°C
dv/dt (2)	Peak diode recovery voltage slope	9	V/ns
E _{AS} (3)	Single pulse avalanche energy	70	mJ
T _{stg}	Storage temperature	-55 to 175	°C
T _j	Max. operating junction temperature	175	°C

^{1.} Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	2.5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	62.5	°C/W
TJ	T _J Maximum lead temperature for soldering purpose		°C

^{2.} $I_{SD} \leq 14A$, di/dt $\leq 300A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $Tj \leq T_{JMAX}$

^{3.} Starting $T_j = 25$ °C, $I_D = 15A$, $V_{DD} = 50V$

Electrical characteristics STP14NF10

2 Electrical characteristics

(T_{CASE}=25 $^{\circ}$ C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0$	100			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = max ratings V_{DS} = max ratings, T_{C} = 125 °C			1 10	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_{D} = 7 \text{ A}$		0.115	0.13	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15 V, I _D = 7 A		20		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0		460 70 30		pF pF pF
$\begin{array}{c} t_{d(on)} \\ t_{r} \\ t_{d(off)} \\ t_{f} \end{array}$	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD} = 50 \text{ V}, I_{D} = 7 \text{ A}$ $R_{G} = 4.7 \Omega V_{GS} = 10 \text{ V}$ (see <i>Figure 14</i>)		16 25 32 8		ns ns ns
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 80 \text{ V}, I_{D} = 12 \text{ A},$ $V_{GS} = 10 \text{ V}$ (see <i>Figure 15</i>)		15.5 3.7 4.7	21	nC nC nC

^{1.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%.

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)				15 60	A A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 14 A, V _{GS} = 0			1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 14 \text{ A},$ $di/dt = 100 \text{ A/}\mu\text{s},$ $V_{DD} = 50 \text{ V}, T_j = 150 ^{\circ}\text{C}$ (see <i>Figure 16</i>)		90 230 5		ns nC A

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STP14NF10

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

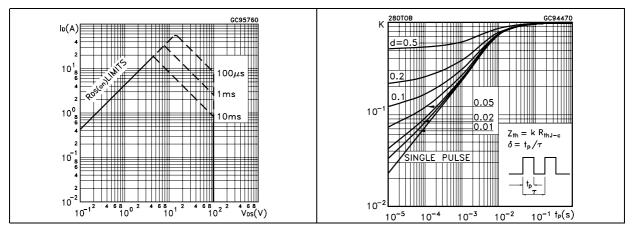


Figure 4. Output characteristics

Figure 5. Transfer characteristics

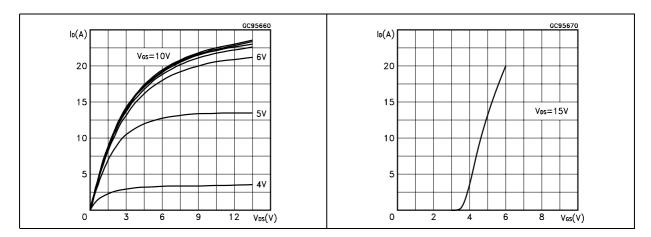


Figure 6. Transconductance

Figure 7. Static drain-source on resistance

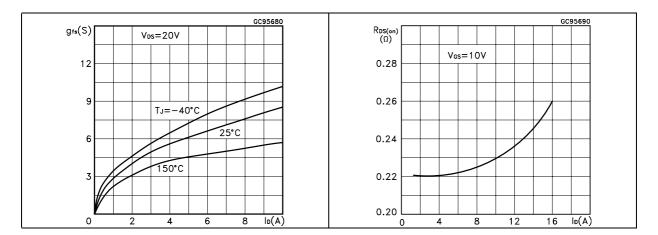


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

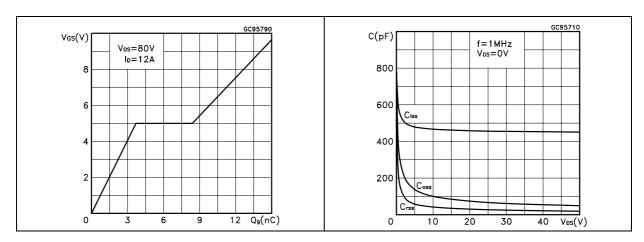


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on resistance vs temperature

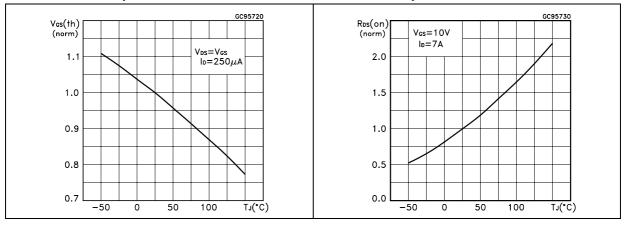
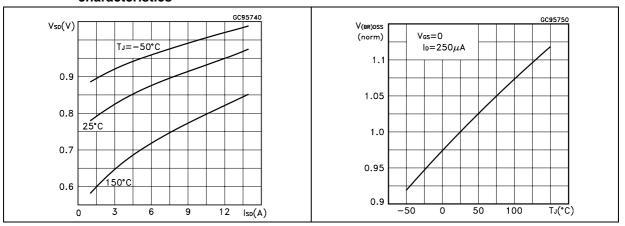


Figure 12. Source-drain diode forward characteristics

Figure 13. Normalized B_{VDSS} vs temperature



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Test circuits STP14NF10

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

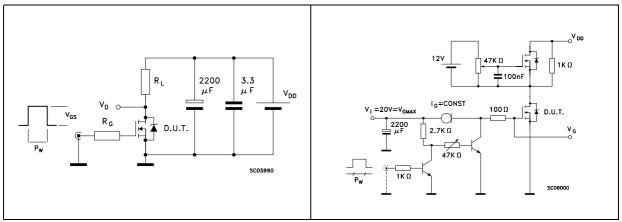


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped Inductive load test circuit

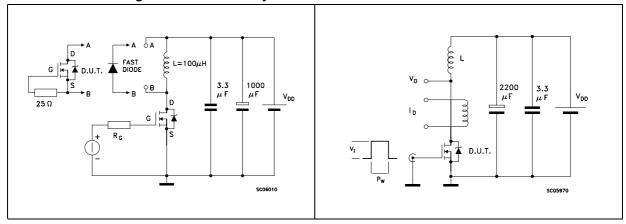
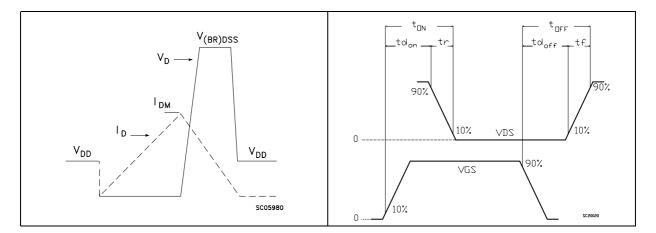


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



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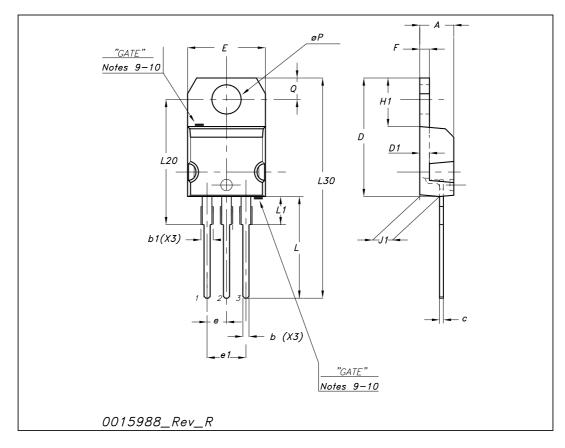
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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TO-220 mechanical data

Dim		mm			inch		
Dim	Min	Тур	Max	Min	Тур	Max	
A	4.40		4.60	0.173		0.181	
b	0.61		0.88	0.024		0.034	
b1	1.14		1.70	0.044		0.066	
С	0.48		0.70	0.019		0.027	
D	15.25		15.75	0.6		0.62	
D1		1.27			0.050		
E	10		10.40	0.393		0.409	
е	2.40		2.70	0.094		0.106	
e1	4.95		5.15	0.194		0.202	
F	1.23		1.32	0.048		0.051	
H1	6.20		6.60	0.244		0.256	
J1	2.40		2.72	0.094		0.107	
L	13		14	0.511		0.551	
L1	3.50		3.93	0.137		0.154	
L20		16.40			0.645		
L30		28.90			1.137		
ØP	3.75		3.85	0.147		0.151	
Q	2.65		2.95	0.104		0.116	



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STP14NF10 Revision history

5 Revision history

Table 7. Document revision history

Date	Revision	Changes
05-Feb-2004	1	First version
21-Jun-2004	2	Preliminary version
19-Jun-2006	3	New template, no content change
20-Mar-2008	4	Removed packages: D ² PAK and TO-220FP

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